

LTCC SURFACE MOUNT

Bandpass Filter

50Ω 11.9 to 12.8 GHz

BFHKI-1272+

THE BIG DEAL

- LTCC Band Pass Filter with Integrated Interposer Board
- Wide Stopband Rejection, Typ. 30dB up to 38GHz
- Shielded Construction
- Protected by US Patents 11,638,370 and 11,744,057

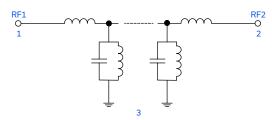


Generic photo used for illustration purposes only

APPLICATIONS

- Test & Measurement Equipment
- Radar
- SATCOM
- Point-to-Point Radios

FUNCTIONAL DIAGRAM



PRODUCT OVERVIEW

BFHKI-1272+ is a miniature low temperature co-fired ceramic (LTCC) ultra-high stopband rejection band pass filter with a 11.9 to 12.8GHz passband, that supports a variety of applications. This model achieves 30dB typical stopband rejection up to 38GHz, when mounted on coplanar waveguide layouts. Housed in a small 4.95mm by 3.65mm ceramic form factor, the filter is ideal for dense signal chain PCB layouts, where it complements MMIC size and performance. The BFHKI family with integrated interposer board enables installation onto PCB layouts with automated manufacturing equipment. This model provides 3.5dB typical insertion loss over a wide band due to its rugged monolithic construction. The LTCC fabrication process assures minimal RF performance variation, while delivering a product that is well suited for environmental extremes of high humidity and temperature.

KEY FEATURES

Features	Advantages
Surface mountable due to Integrated Interposer Board	Enables installation with automated manufacturing equipment, making this suitable for high-volume processes.
Wide Rejection	Provides high stopband rejection of 30dB typical up to 38GHz.
Small Size (4.95 x 3.65mm)	Allows for high layout density of circuit boards, while minimizing effects of parasitics.
Wide Operating and Storage Temperature (-55 to 125°C)	Enables use in high reliability and extreme environment conditions, such as in aerospace & defense applications.
Cost Effective	LTCC is a scalable technology that is cost effective due to ease of production in high-volume

REV. OR ECO-018846 BFHKI-1272+ MCL NY 231020



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ELECTRICAL SPECIFICATIONS^{1,2,3} AT +25°C

Parameter		F#	Frequency (GHz)	Min.	Тур.	Max.	Units	
	Center Frequency ⁴	_	_	_	12.35	_	GHz	
Passband	Insertion Loss	F2-F3	11.9 - 12.8	_	3.5	5	dB	
	Return Loss	F2-F3	11.9 - 12.8	_	10	_	dB	
Stop Band, Lower	Rejection	DC-F1	0.1 - 8.6	55	65	_	dB	
Cton Donal House	Rejection	Decid Heavy Defeation	F4 FF	16.7 - 35	30	35	_	-ID
Stop Band, Upper		F4-F5	35 - 38	25	30		dB	

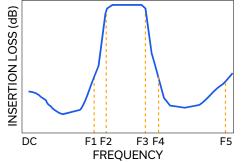
- 1. Tested on Evaluation Board P/N TB-BFHKI-1272C+. Measured with the connector and feedline effects de-embedded using the 2XThru IEEE P370 method.
- 2. Bi-directional RF1 and RF2 ports can be interchanged.
- 3. This component should not be used as a DC-block. In applications where DC voltage and/or current is present at either the input or output ports, external DC blocking capacitors are required.
- 4. Typical variation ±5%

ABSOLUTE MAXIMUM RATINGS⁵

Parameter	Ratings
Operating Temperature	-55°C to +125°C
Storage Temperature	-55°C to +125°C
Input Power ⁶	1W

- 5. Permanent damage may occur if any of these limits are exceeded.
- 6. Power rating applies only to signals within the passband. Power rating above +25°C operating temperature decreases linearly to 0.5W at +125°C.

TYPICAL FREQUENCY RESPONSE AT +25°C



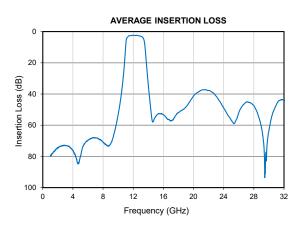
LTCC SURFACE MOUNT

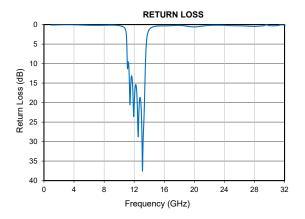
Bandpass Filter

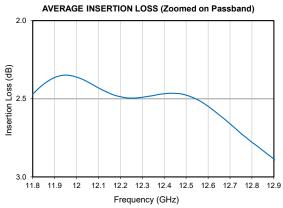
BFHKI-1272+

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TYPICAL PERFORMANCE GRAPHS AT +25°C







LTCC SURFACE MOUNT

Bandpass Filter

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FUNCTIONAL DIAGRAM

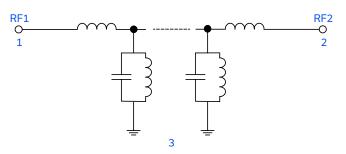
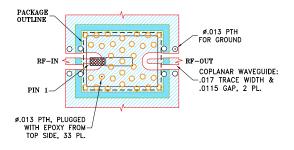


Figure 1. BFHKI-1272+ Functional Diagram

PAD DESCRIPTION

Function	Pad Number	Description			
RF1 ²	1	Connects to RF Input Port			
RF2 ²	2	Connects to RF Output Port			
GROUND	3	Connects to Ground on PCB, (See drawing PL-753)			

SUGGESTED PCB LAYOUT (PL-753)

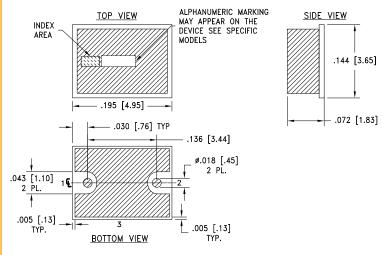


NOTES:

- 1. TRACE WIDTH & GAP PARAMETERS ARE SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS .010"; COPPER: 1/2 0Z. FOR OTHER MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED. 2. BOTTOM SIDE OF THE PCB ARE CONTINUOUS GROUND PLANE.
- DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER) DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

Figure 2. Suggested PCB Layout BFHKI-1272+

CASE STYLE DRAWING



METALLIZATION

Weight: .135 grams.

Dimensions are in inches [mm]. Tolerances: 2 Pl.±.01; 3 Pl. ±.005

PRODUCT MARKING*: F443

*Marking may contain other features or characters for internal lot control.



Bandpass Filter

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ADDITIONAL DETAILED INFORMATION IS AVAILABLE ON OUR DASH BOARD.

CLICK HERE

	Data
Performance Data & Graphs	Graphs
	S-Parameter (S2P Files) Data Set (.zip file) De-embedded to device pads
Case Style	NM3237 Finish: Gold over Nickel Plating
RoHS Status	Compliant
Tape and Reel	TR-F77
Suggested Layout for PCB Design	PL-753
Evaluation Board	TB-BFHKI-1272C+
Lvaluation Board	Gerber File
Environmental Rating	ENV06T12

NOTES

- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
- B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuits' applicable established test performance criteria and measurement instructions.
- C. The parts covered by this specification document are subject to Mini-Circuits' standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the standard terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/terms/viewterm.html



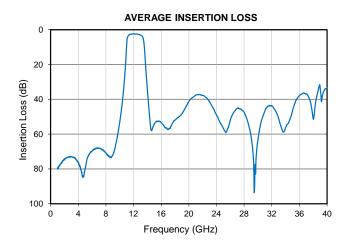
LTCC Bandpass Filter

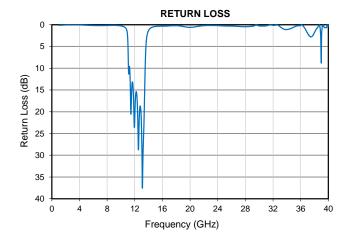
BFHKI-1272+

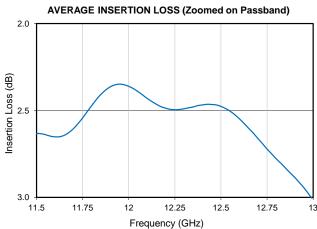
cal Performand		
FREQUENCY (MHz)	INSERTION LOSS (dB)	RETURN LOSS (dB)
100	100.50	0.03
1000	79.99	0.12
2000	74.48	0.05
3000	73.13	0.01
4000	76.30	0.03
5000	79.92	0.11
6000	69.83	0.18
7000	68.15	0.20
8000	70.73	0.17
8600	73.31	0.16
9000	71.99	0.15
10000	53.18	0.27
10500	37.02	0.52
11000	9.19	4.00
11500	2.63	17.78
11900	2.36	21.82
12200	2.49	15.39
12500	2.48	27.29
12800	2.78	18.71
13500	7.28	10.16
14000	34.39	1.31
15000	54.30	0.39
16000	53.32	0.33
16700	56.35	0.29
17000	57.31	0.27
18000	52.00	0.21
19000	48.27	0.40
20000	41.18	0.59
21000	37.65	0.41
22000	37.72	0.22
23000	41.41	0.17
24000	48.98	0.20
25000	56.78	0.28
26000	52.00	0.31
27000	45.11	0.38
28000	47.50	0.46
29000	61.30	0.33
30000	63.15	0.33
31000	46.77	0.25
32000	43.72	0.13
33000	51.14	0.13
34000	56.33	1.09
35000	46.57	0.55
36000	37.89	0.14
38000	51.28	1.75
40000	33.40	0.40



Typical Performance Data



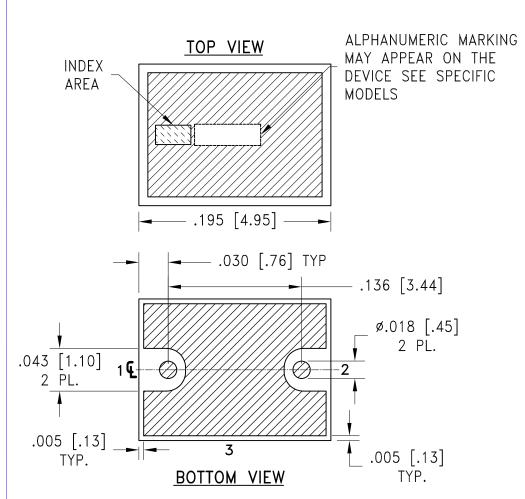


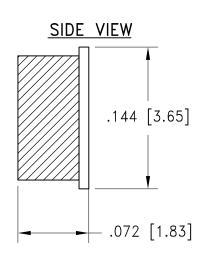


NM

Outline Dimensions

NM3237







Weight: .135 grams.

Dimensions are in inches (mm). Tolerances: 2 Pl.±.01; 3 Pl. ±.005

Notes:

1. Case material: LTCC on printed circut board base.

2. Termination Finish: as shown below or indicated on Data Sheet.
For RoHS Case Styles: Gold Plate over Nickel plate. All models, (+) suffix.



INTERNET http://www.minicircuits.com

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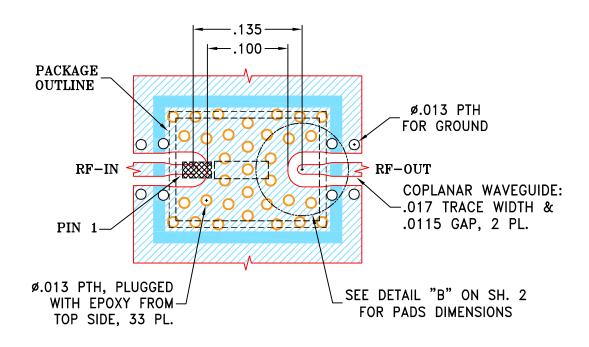
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THIRD ANGLE PROJECTION

	REVISIONS							
REV	ECN No.	DESCRIPTION	DATE	DR	AUTH			
OR	ECO-017025	NEW RELEASE	03/30/23	ITG	IL			
OR1	ECO-018201	CORRECTED TYPO IN NOTE 2	06/16/23	ITG	IL			
A	ECO-020890	ADDED DETAIL "A" (SH.2) & DIMENSIONS	02/16/24	ITG	IL			

SUGGESTED MOUNTING CONFIGURATION FOR NM3237 CASE STYLE



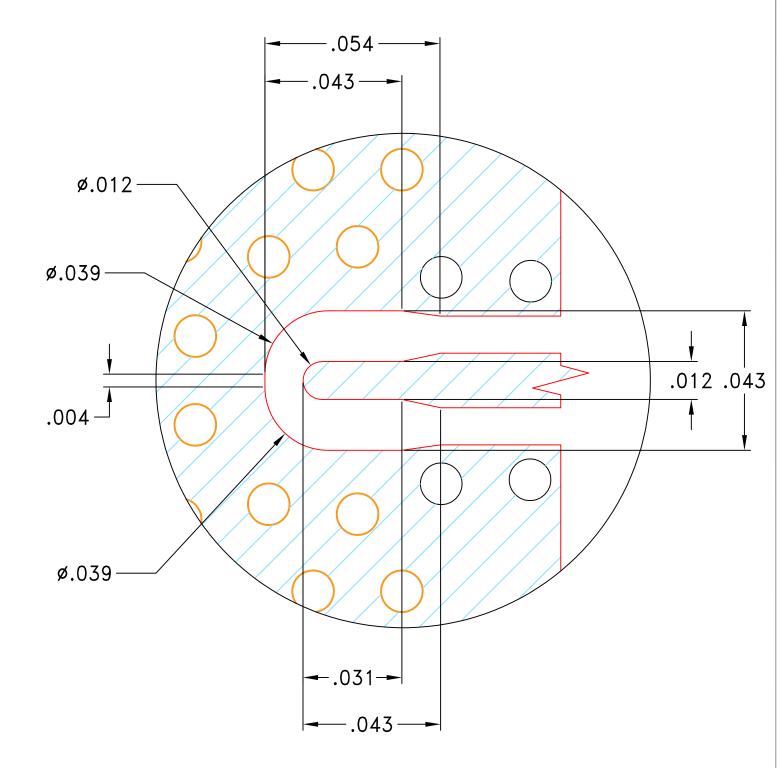
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- 2. BOTTOM SIDE OF THE PCB ARE CONTINUOUS GROUND PLANE.

ASHEETA1.DWG REV:A DATE:01/12/95

DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)

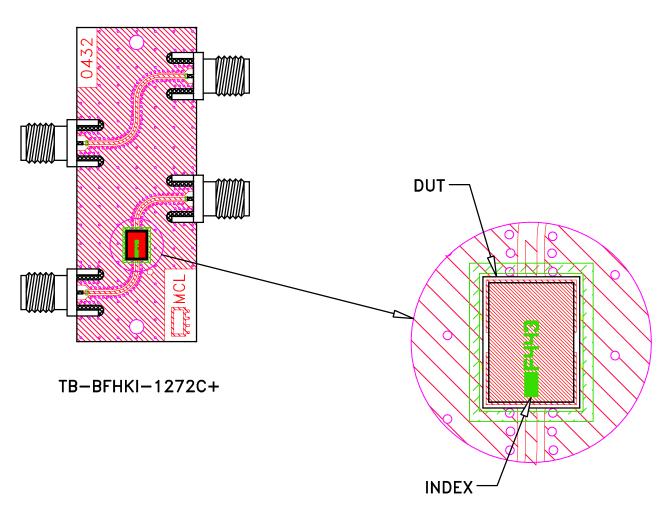
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UNLESS OTHERWISE SPECIFIED		INITIALS	DATE			. ~:		• 4 R			
DIMENSIONS ARE IN INCHES	DRAWN	ITG	03/30/23		\sqcup Mini	i-Cir	'cu	1ts 13.1	Neptu	ne Aver NY 112	nue
TOLERANCES ON: 2 PL DECIMALS ±	CHECKED	GF	03/30/23		Τ			Broc	окіуп	NI 114	೭35
3 PL DECIMALS ± .005 ANGLES ±	APPROVED	IL	03/30/23								
FRACTIONS ±					PL.	NM323	37. ^r	$\Gamma B - 120$	00		
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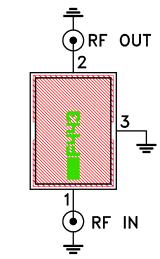


DETAIL "A". SOLDER MASK IS NOT SHOWN FOR CLARITY

(SCALE 4:1)

Evaluation Board and Circuit



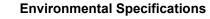


Schematic Diagram

Notes:

- 1. SMA Female connectors.
- 2. PCB Material: Rogers R04350 or equivalent, Dielectric Constant=3.5, Thickness=.010 inch.

Mini-Circuits®



ENV06T12



All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-55° to 125° C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 125° C Ambient Environment	Individual Model Data Sheet
Thermal Cycling	-55 to 125°C, 100 cycles, Dwell Time 15 minutes.	MIL-STD-202, Method 107, Condition A-3
Humidity	85°C, 90-95% Relative Humidity, 250hours	
Solderability	10X / 30X Magnification	J-STD-002C Test S, J-STD-002C Test S1
High Temp Storage	125°C, 250 hours	
Bend Test	1mm, deflection for 5 seconds Span of bending: 2.75"	

ENV06T12Rev: OR

06/27/23

DCO-1237 File: ENV06T12.pdf